

Triacs

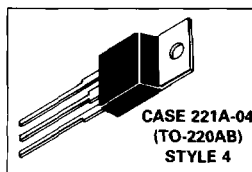
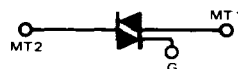
Silicon Bidirectional Triode Thyristors

... designed primarily for full-wave ac control applications, such as light dimmers, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied anode voltage with positive or negative gate triggering.

- Blocking Voltage to 800 Volts
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in Two Modes (2N6342A, 2N6343A, 2N6344A, 2N6345A) or Four Modes (2N6346A, 2N6347A, 2N6348A, 2N6349A)
- For 400 Hz Operation, Consult Factory
- 8 Ampere Devices Available as 2N6342 thru 2N6349

**2N6342A
thru
2N6345A
2N6346A
thru
2N6349A**

**TRIACs
12 AMPERES RMS
200 thru 800 VOLTS**



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MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted.)

Rating	Symbol	Value	Unit
*Peak Repetitive Off-State Voltage, Note 1 (Gate Open, $T_J = -40$ to $+110^\circ\text{C}$) 1/2 Sine Wave 50 to 60 Hz, Gate Open 2N6342A, 2N6346A 2N6343A, 2N6347A 2N6344A, 2N6348A 2N6345A, 2N6349A	V_{DRM}	200 400 600 800	Volts
*RMS On-State Current ($T_C = +80^\circ\text{C}$) (Full Cycle Sine Wave 50 to 60 Hz) ($T_C = +95^\circ\text{C}$)	$I_T(\text{RMS})$	12 6	Amps
*Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, $T_C = +80^\circ\text{C}$) Preceded and Followed by Rated Current	I_{TSM}	120	Amps
Circuit Fusing ($t = 8.3$ ms)	I^2t	59	A^2s
*Peak Gate Power ($T_C = +80^\circ\text{C}$, Pulse Width = 2 μs)	P_{GM}	20	Watts
*Average Gate Power ($T_C = +80^\circ\text{C}$, $t = 8.3$ ms)	$P_{G(AV)}$	0.5	Watt
*Peak Gate Current	I_{GM}	2	Amps
*Peak Gate Voltage	V_{GM}	± 10	Volts
*Operating Junction Temperature Range	T_J	-40 to $+125$	$^\circ\text{C}$
*Storage Temperature Range	T_{stg}	-40 to $+150$	$^\circ\text{C}$

*Indicates JEDEC Registered Data.

Note 1. V_{DRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Devices listed in bold, italic are Motorola preferred devices.

2N6342A thru 2N6349A

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
*Thermal Resistance, Junction to Case	$R_{\theta JC}$	2	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}\text{C}$, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
*Peak Blocking Current ($V_D = \text{Rated } V_{DRM}$, gate open) $T_J = 25^{\circ}\text{C}$ $T_J = 110^{\circ}\text{C}$	I_{DRM}	—	—	10 2	μA mA
*Peak On-State Voltage (Either Direction) ($I_{TM} = 17 \text{ A Peak}$; Pulse Width = 1 to 2 ms, Duty Cycle $\leq 2\%$)	V_{TM}	—	1.3	1.75	Volts
Gate Trigger Current (Continuous dc) ($V_D = 12 \text{ Vdc}$, $R_L = 100 \text{ Ohms}$) MT2(+), G(+) All Types MT2(+), G(-) 2N6346A thru 2N6349A MT2(-), G(-) All Types MT2(-), G(+) 2N6346A thru 2N6349A *MT2(+), G(+); MT2(-), G(-) $T_C = -40^{\circ}\text{C}$ All Types *MT2(+), G(-); MT2(-), G(+) $T_C = -40^{\circ}\text{C}$ 2N6346A thru 2N6349A	I_{GT}	—	6 6 10 25	50 75 50 75 100 125	mA
Gate Trigger Voltage (Continuous dc) ($V_D = 12 \text{ Vdc}$, $R_L = 100 \text{ ohms}$) MT2(+), G(+) All Types MT2(+), G(-) 2N6346A thru 2N6349A MT2(-), G(-) All Types MT2(-), G(+) 2N6346A thru 2N6349A *MT2(+), G(+); MT2(-), G(-) $T_C = -40^{\circ}\text{C}$ All Types *MT2(+), G(-); MT2(-), G(+) $T_C = -40^{\circ}\text{C}$ 2N6346A thru 2N6349A ($V_D = \text{Rated } V_{DRM}$, $R_L = 10 \text{ k ohms}$, $T_J = 100^{\circ}\text{C}$) *MT2(+), G(+); MT2(-), G(-) All Types *MT2(+), G(-); MT2(-), G(+) 2N6346A thru 2N6349A	V_{GT}	—	0.9 0.9 1.1 1.4	2 2.5 2 2.5 2.5 3	Volts
Holding Current (Either Direction) ($V_D = 12 \text{ Vdc}$, Gate Open) $T_C = 25^{\circ}\text{C}$ ($I_T = 200 \text{ mA}$) * $T_C = -40^{\circ}\text{C}$	I_H	—	6 —	40 75	mA
*Turn-On Time ($V_D = \text{Rated } V_{DRM}$, $I_{TM} = 17 \text{ A}$, $I_{GT} = 120 \text{ mA}$, Rise Time = $0.1 \mu\text{s}$, Pulse Width = $2 \mu\text{s}$)	t_{gt}	—	1.5	2	μs
Critical Rate of Rise of Commutation Voltage ($V_D = \text{Rated } V_{DRM}$, $I_{TM} = 17 \text{ A}$, Commutating $di/dt = 6.1 \text{ A/ms}$, Gate Unenergized, $T_C = 80^{\circ}\text{C}$)	$dv/dt(c)$	—	5	—	$\text{V}/\mu\text{s}$

*Indicates JEDEC Registered Data.

FIGURE 1 - RMS CURRENT DERATING

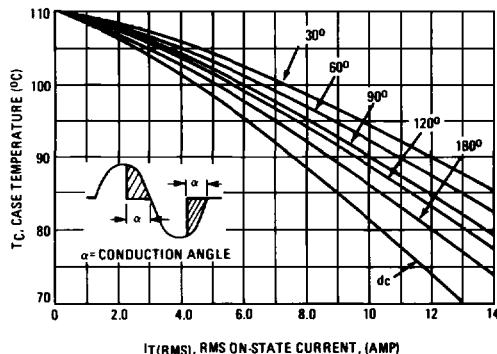
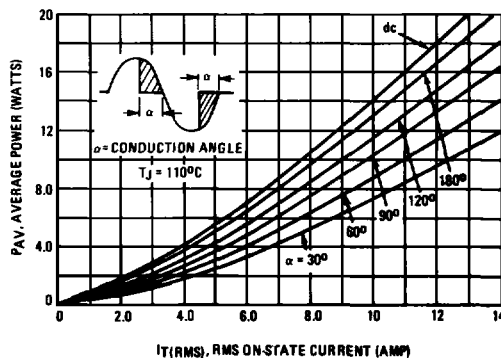


FIGURE 2 - ON-STATE POWER DISSIPATION



2N6342A thru 2N6349A

FIGURE 3 – TYPICAL GATE TRIGGER VOLTAGE

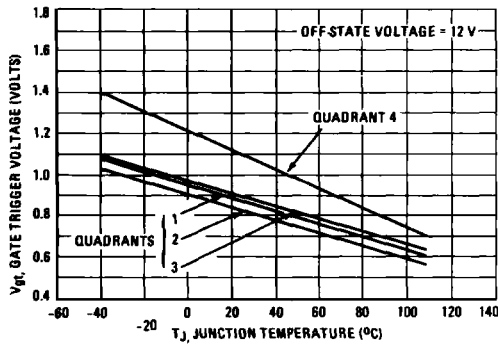


FIGURE 4 – TYPICAL GATE TRIGGER CURRENT

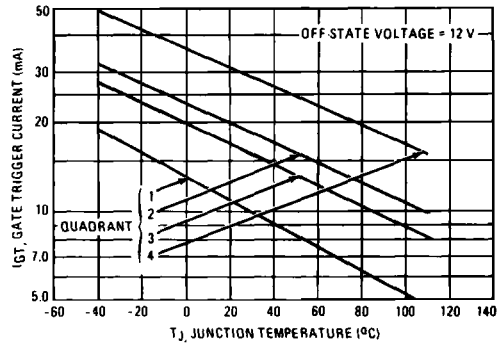


FIGURE 5 – ON-STATE CHARACTERISTICS

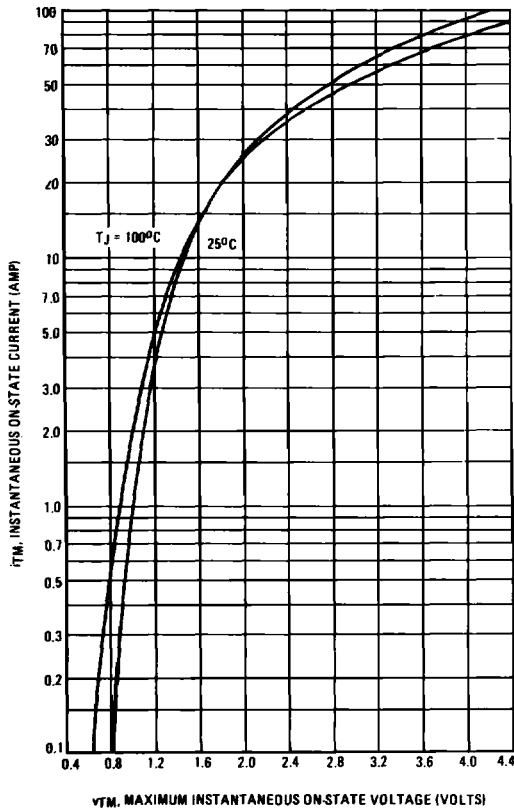


FIGURE 6 – TYPICAL HOLDING CURRENT

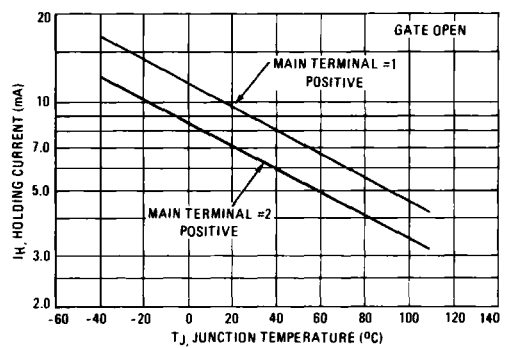
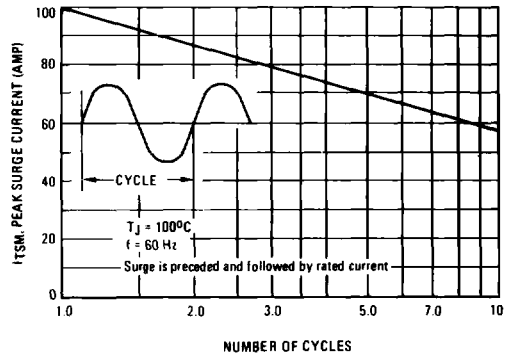


FIGURE 7 – MAXIMUM NON-REPETITIVE SURGE CURRENT



2N6342A thru 2N6349A

FIGURE 8 – TYPICAL THERMAL RESPONSE

